

## PATENT ASSIGNMENT COVER SHEET

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<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
YOONKYUNG PARK	05/12/2016
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<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	15112118
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<b>DATE SIGNED:</b>	07/18/2016
<b>Total Attachments: 2</b>	
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**ASSIGNMENT OF RIGHTS, TITLE AND INTEREST IN INVENTION**

- United States of America rights, title and interest in the invention*
- Foreign rights, title and interest in the invention*
- United States Patent Application Serial No. \_\_\_\_\_  
Date of Execution: \_\_\_\_\_ Date of Filing: \_\_\_\_\_*
- United States Provisional Patent Application Serial No. \_\_\_\_\_*
- United States Patent No(s). \_\_\_\_\_*
- International (PCT) Patent Application Serial No. \_\_\_\_\_*
- Other (specify) \_\_\_\_\_*

*Title of the Invention:*

ANALOGUE PEPTIDE CMA3 DERIVED FROM CM-MA PEPTIDE AND USE THEREOF

*Inventors (assignors):*

<i>Name</i>	<i>Address</i>
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Whereas, we, the above-identified inventors, have invented certain new and useful improvements in the invention identified above and described in the above-identified patent application(s) and /or patent(s) (hereinafter referred to as "invention");

And, whereas we desire to assign our above-identified rights, title and interest in the invention to the above-identified Assignees;

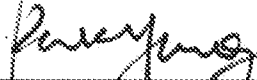
Now, this indenture witnesseth, that for good and valuable consideration, the receipt whereof is hereby acknowledged;

We hereby assign, sell and transfer our above-identified rights, title and interest in said invention, said application(s) as identified above, including any divisions, continuations, and continuations-in-part thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all reissues and reexaminations thereof, which may be granted or have granted for said invention, and in and to any and all priority rights, Convention rights, and other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, unto said Assignees;

And we hereby authorize and request the Commissioner of Patents and Trademarks to issue any United States Letters Patent which may issue for said Invention to said Assignees, as assignee of the whole right, title and interest thereto;

And we further agree to sign and execute all necessary and lawful future documents, including applications for foreign patents, for filing divisions, continuations and continuation-in-part of said application for patent and/or for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid Invention, as the Assignees or its Designee(s) may from time to time require and prepare at its own expense.

*Inventors' Signatures:*

Name	Signature/ Date
PARK, YOONKYUNG	 May 12, 2016